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(12) **United States Design Patent** (10) **Patent No.:** **US D491,899 S**  
**Yagi** (45) **Date of Patent:** **\*\* Jun. 22, 2004**

(54) **LIGHT EMITTING DIODE**

- (75) Inventor: **Tetsuya Yagi**, Anan (JP)
- (73) Assignee: **Nichia Corporation**, Anan (JP)
- (\*\*) Term: **14 Years**

- (21) Appl. No.: **29/191,319**
- (22) Filed: **Oct. 7, 2003**

**Related U.S. Application Data**

- (62) Division of application No. 29/161,015, filed on May 22, 2002.
- (51) **LOC (7) Cl.** ..... **13-03**
- (52) **U.S. Cl.** ..... **D13/180**
- (58) **Field of Search** ..... D13/104, 114, D13/180, 182; D26/37; 174/52.2; 257/79, 88, 89, 93-96, 91, 98, 99, 100, 432, 433, 434, 678, 684, 698; 313/499, 500; 362/35, 226, 249, 287, 294, 800

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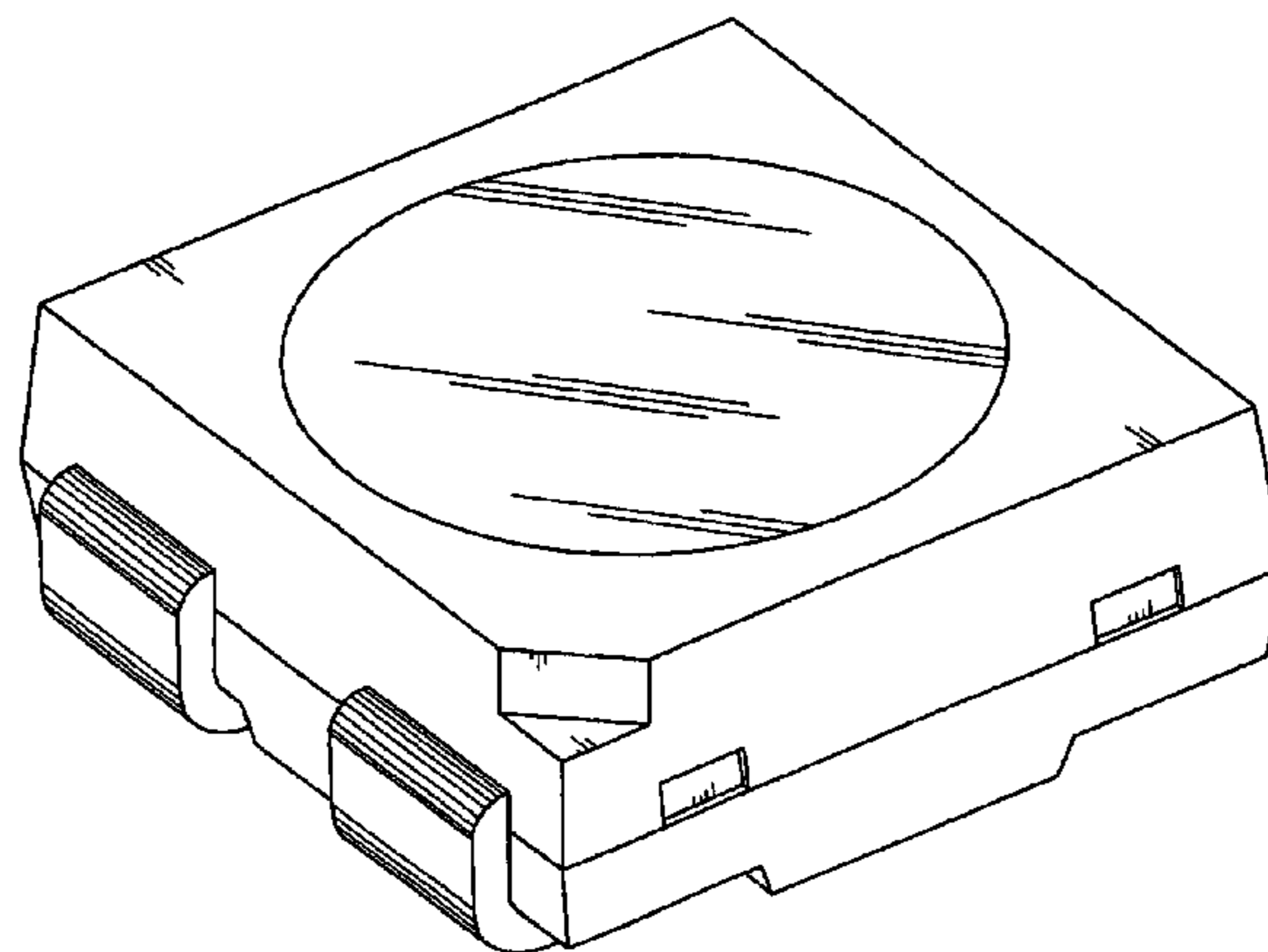
(57) **CLAIM**

I claim the ornamental design for a light emitting diode, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a light emitting diode showing my new design;  
FIG. 2 is a top plan view of the light emitting diode according to the embodiment of FIG. 1;  
FIG. 3 is a left side elevational view of the light emitting diode according to the embodiment of FIG. 1;  
FIG. 4 is a front elevational view of the light emitting diode according to the embodiment of FIG. 1;  
FIG. 5 is a right side elevational view of the light emitting diode according to the embodiment of FIG. 1;  
FIG. 6 is a bottom plan view of the light emitting diode according to the embodiment of FIG. 1;  
FIG. 7 is a rear elevational view of the light emitting diode according to the embodiment of FIG. 1;  
FIG. 8 is a top plan view of the light emitting diode according to another embodiment of my new design;  
FIG. 9 is a left side elevational view of the light emitting diode according to the embodiment of FIG. 8;  
FIG. 10 is a front elevational view of the light emitting diode according to the embodiment of FIG. 8;  
FIG. 11 is a right side elevational view of the light emitting diode according to the embodiment of FIG. 8;  
FIG. 12 is a bottom plan view of the light emitting diode according to the embodiment of FIG. 8; and,  
FIG. 13 is a rear elevational view of the light emitting diode according to the embodiment of FIG. 8.

**1 Claim, 3 Drawing Sheets**



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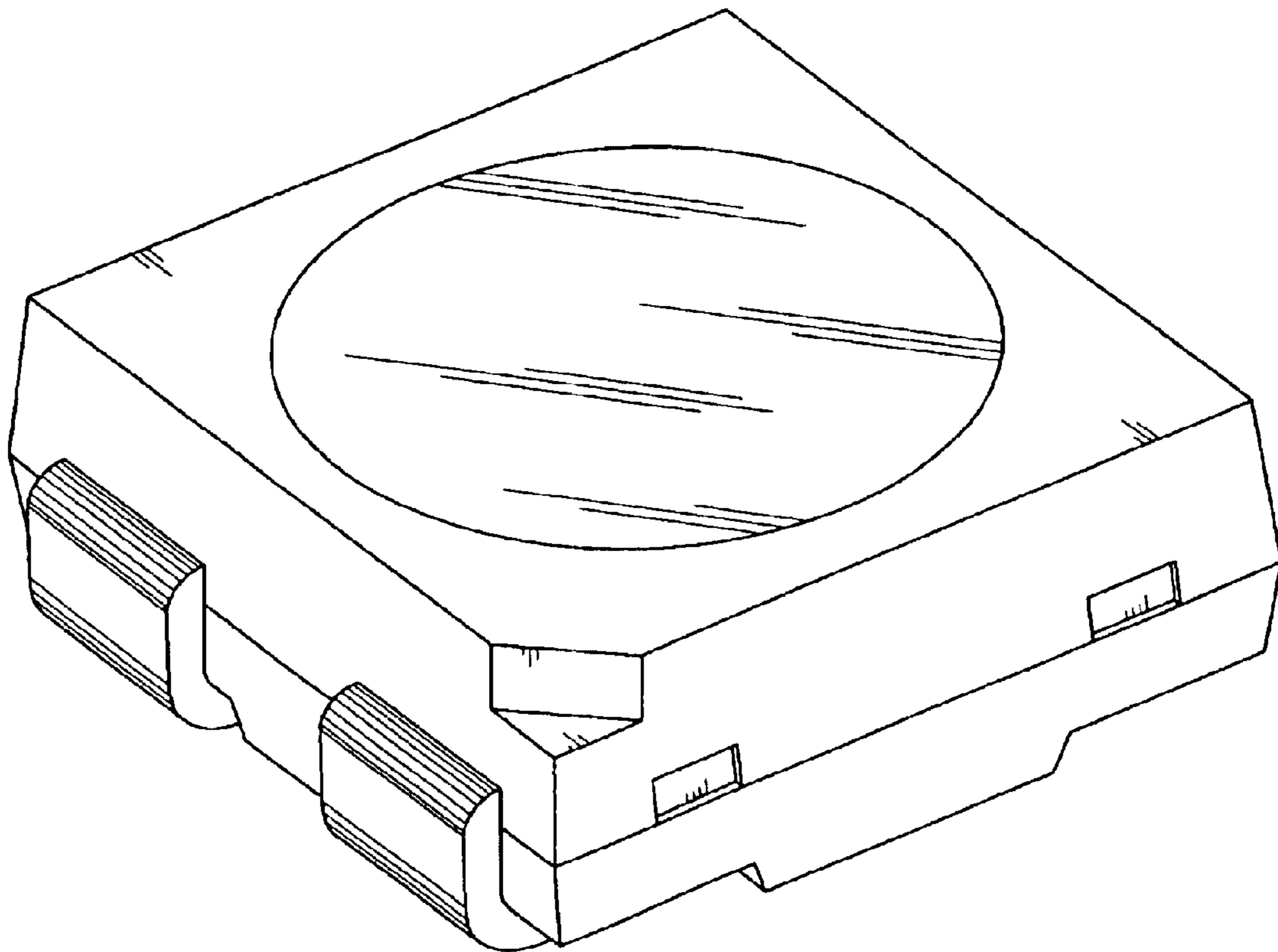


FIG. 1

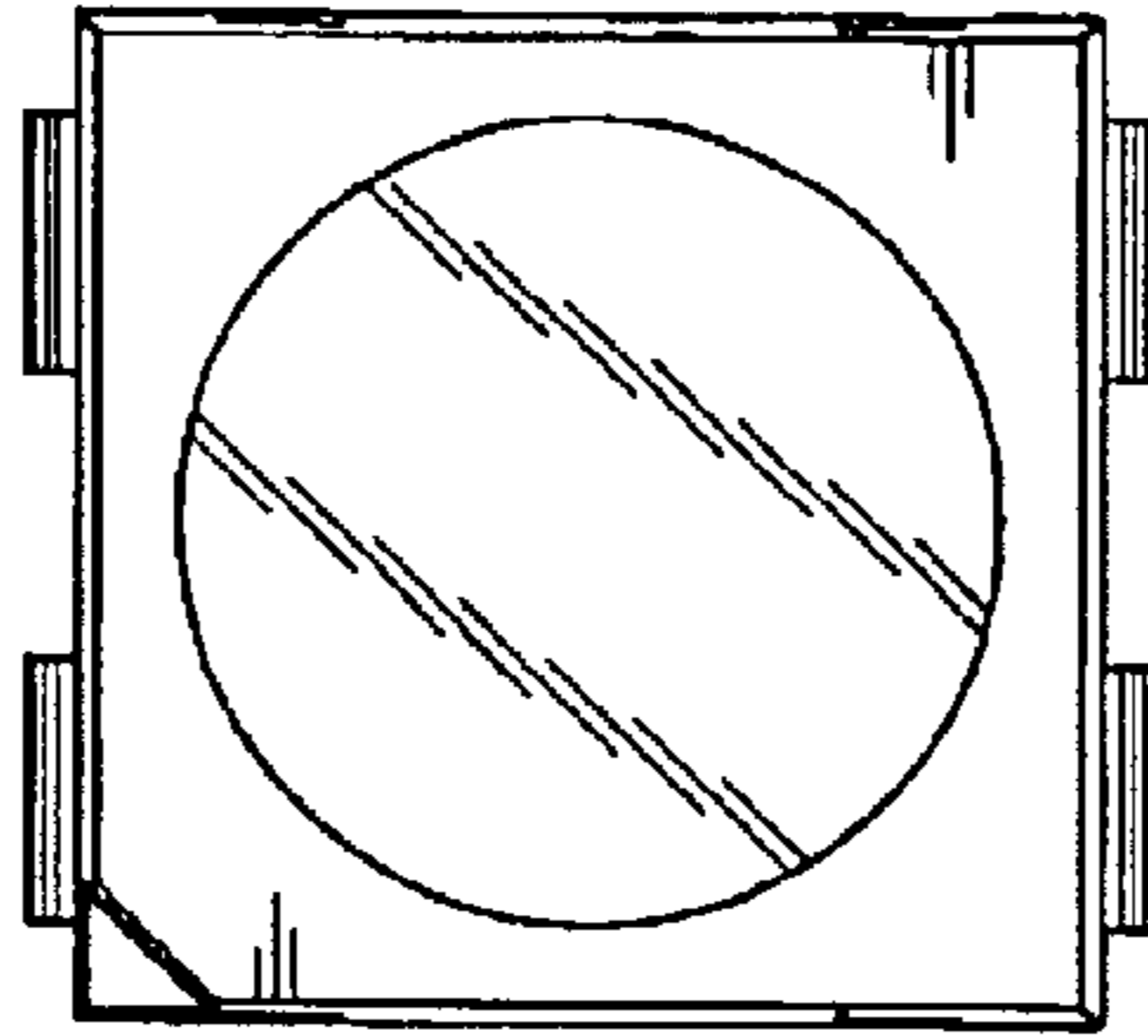


FIG. 2

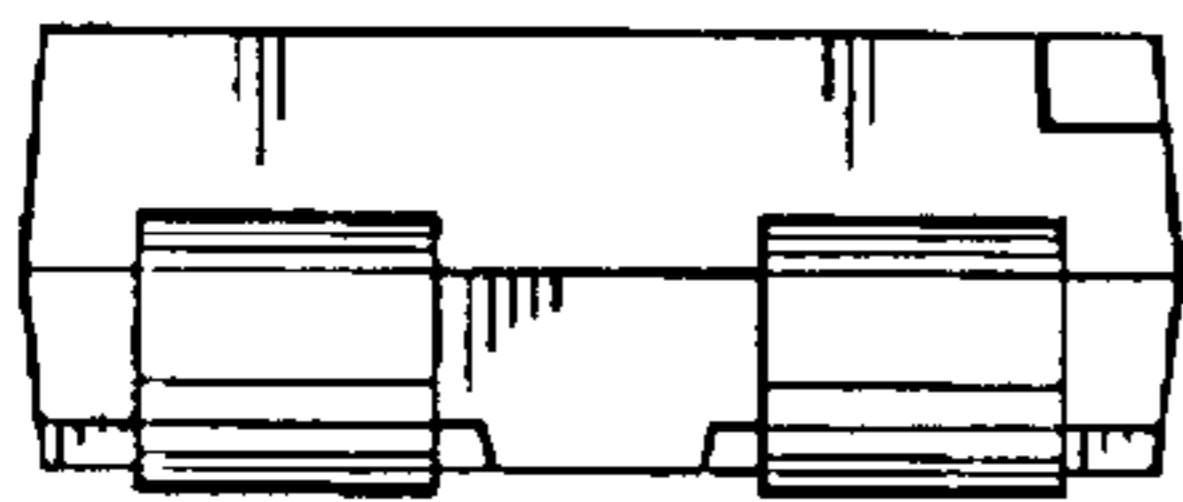


FIG. 3



FIG. 4

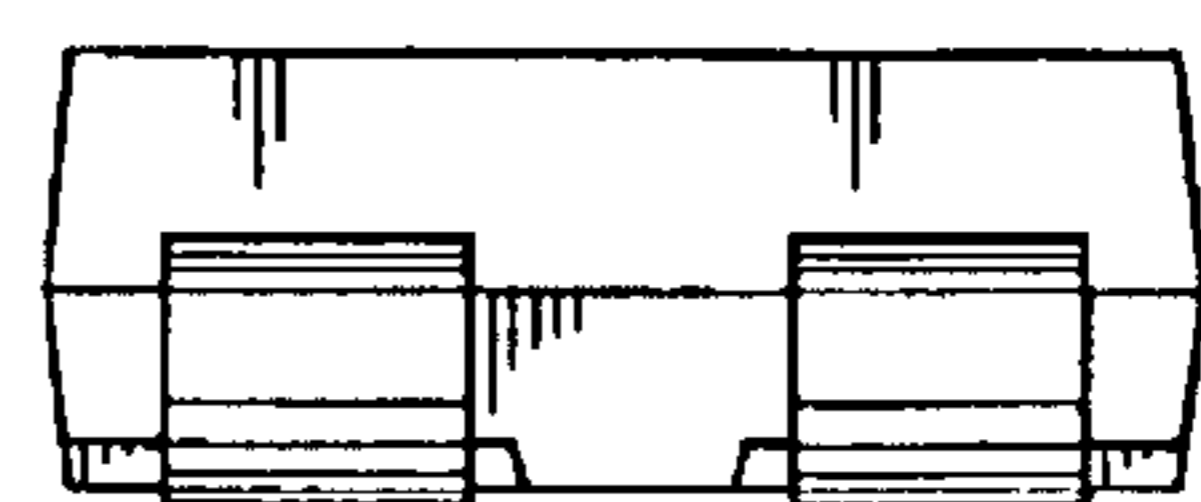


FIG. 5

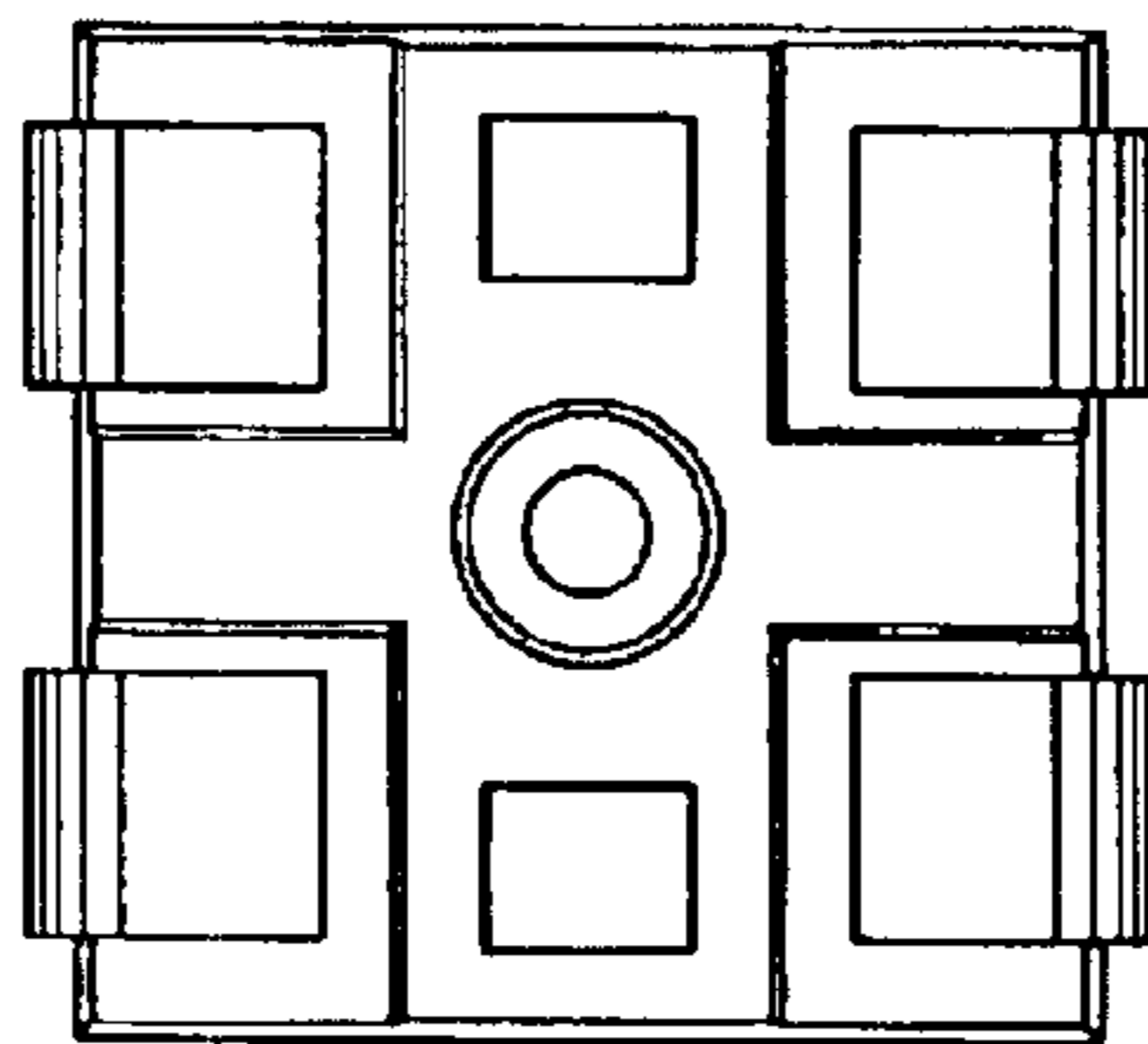


FIG. 6

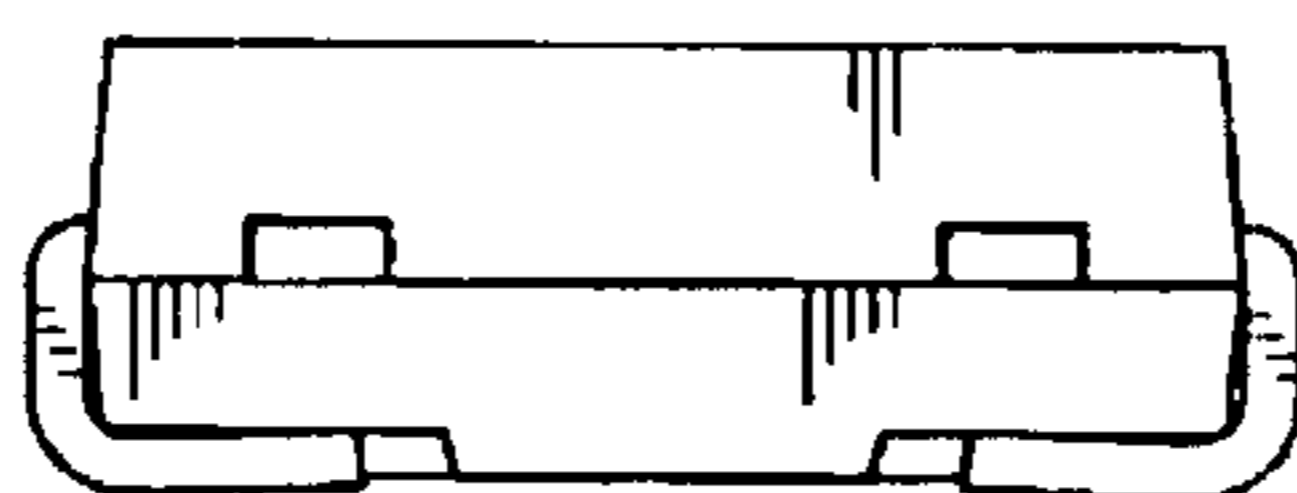


FIG. 7

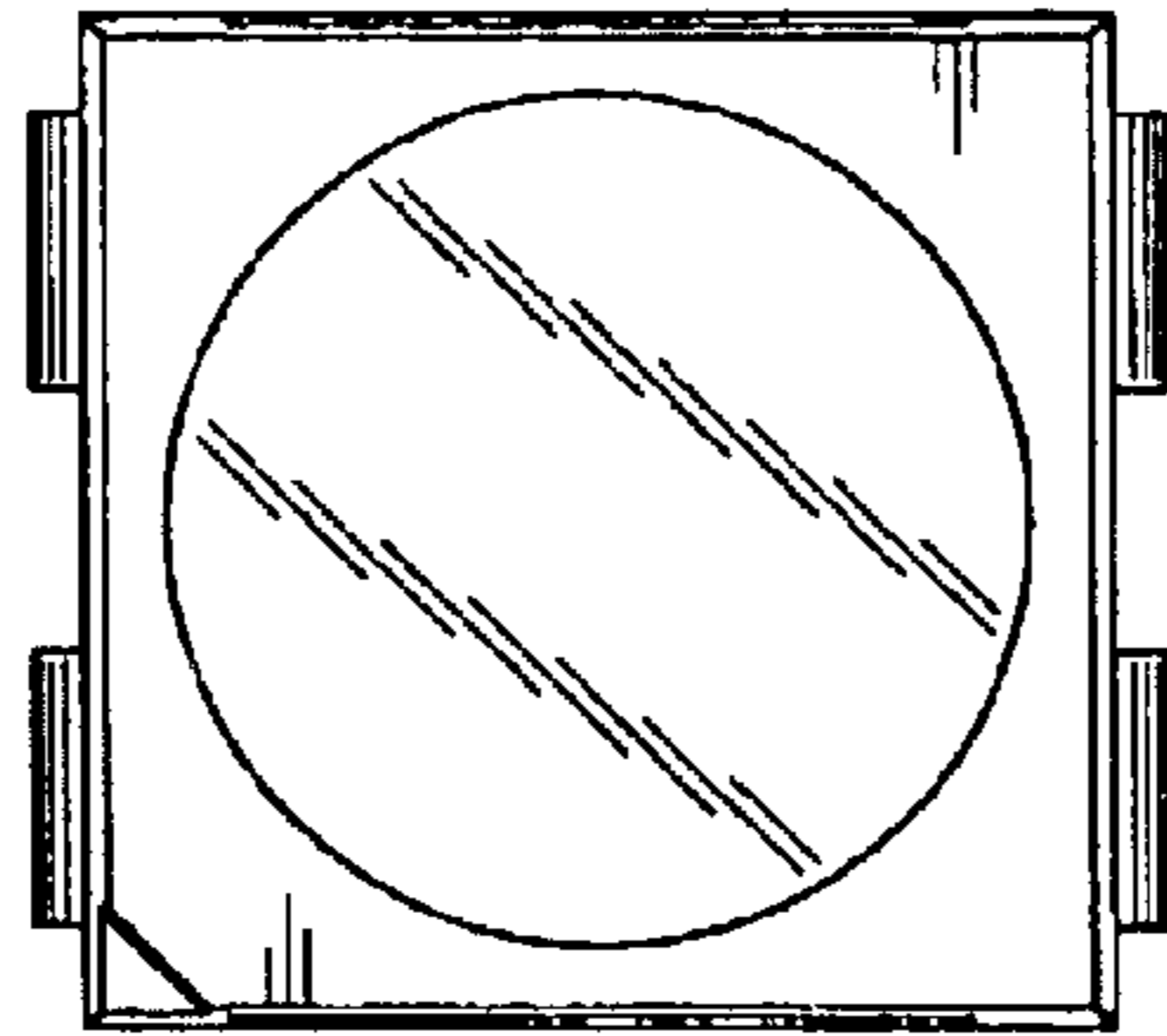


FIG. 8

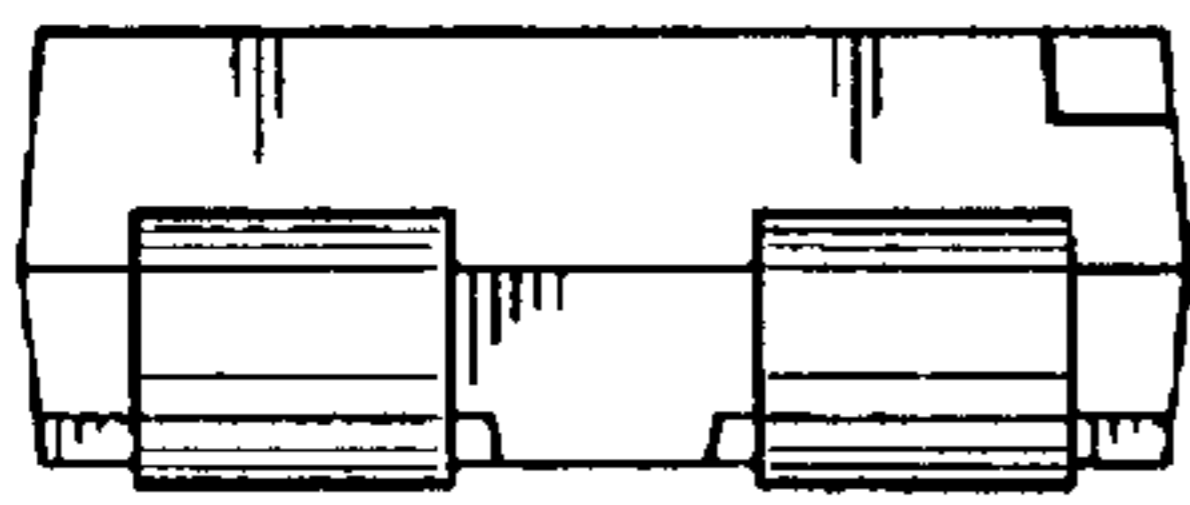


FIG. 9

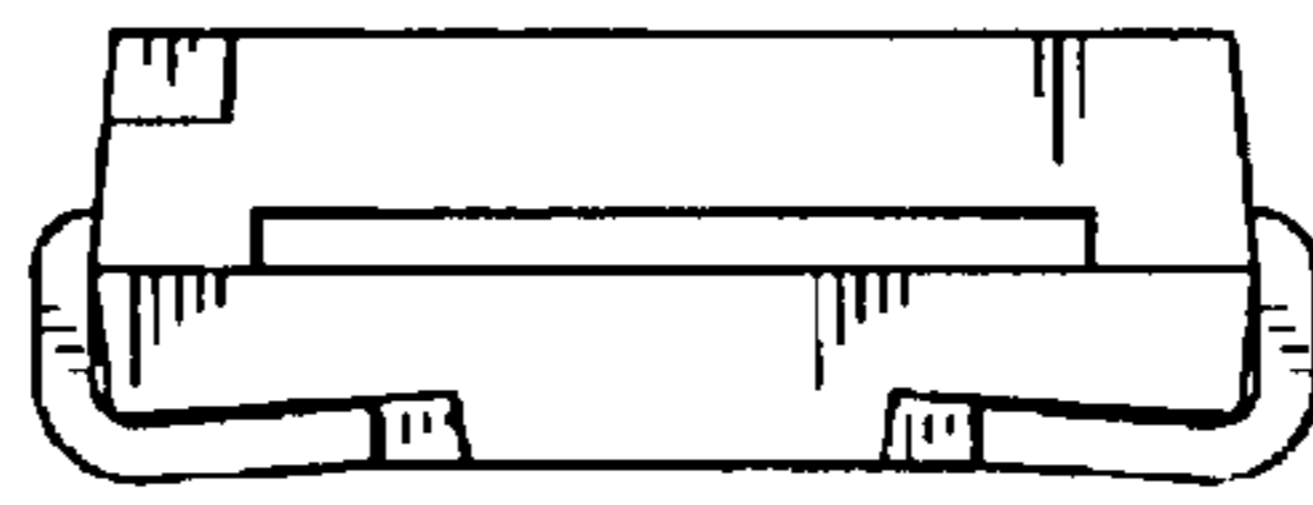


FIG. 10

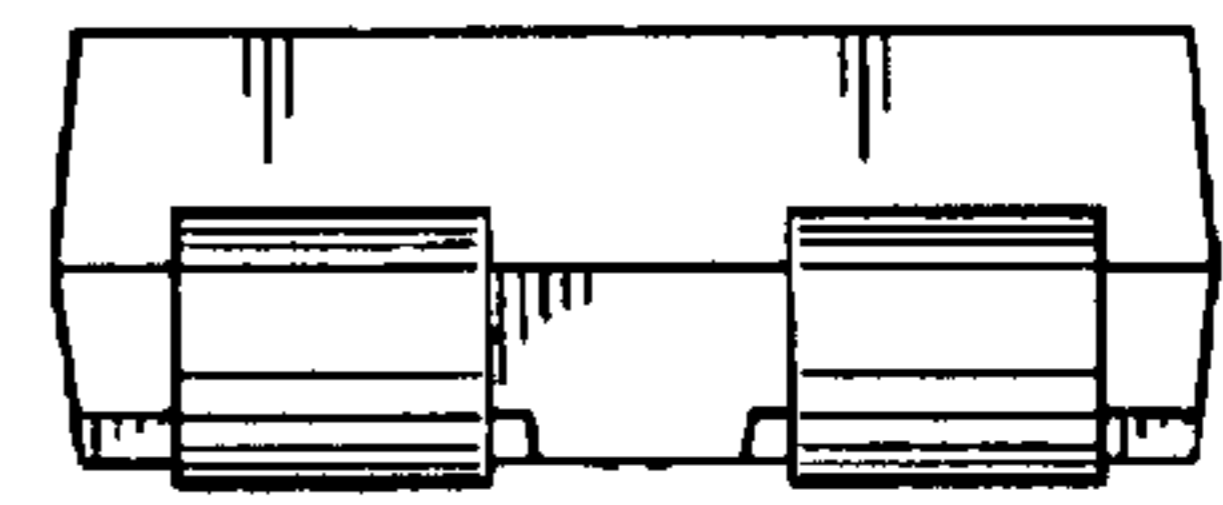


FIG. 11

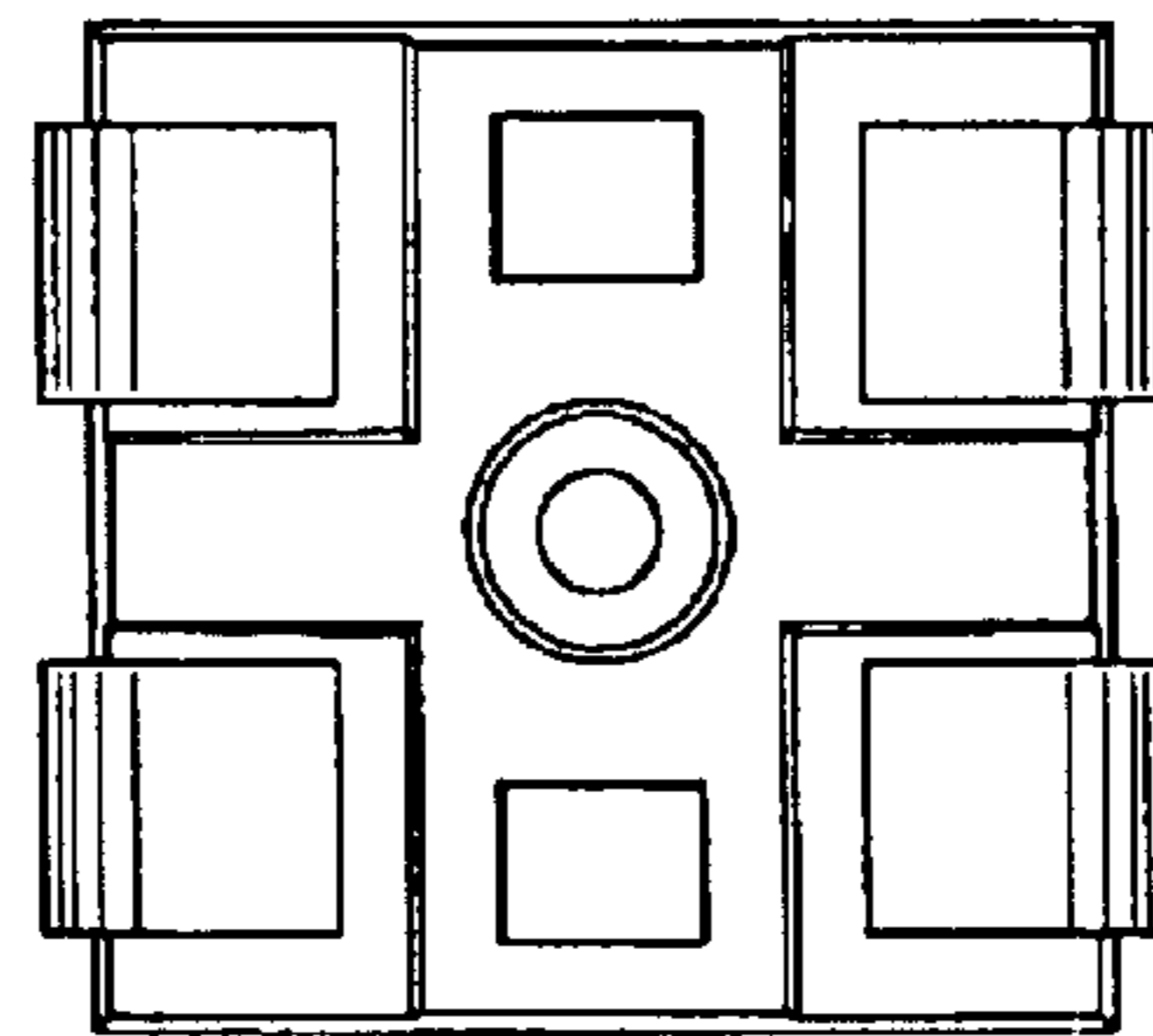


FIG. 12

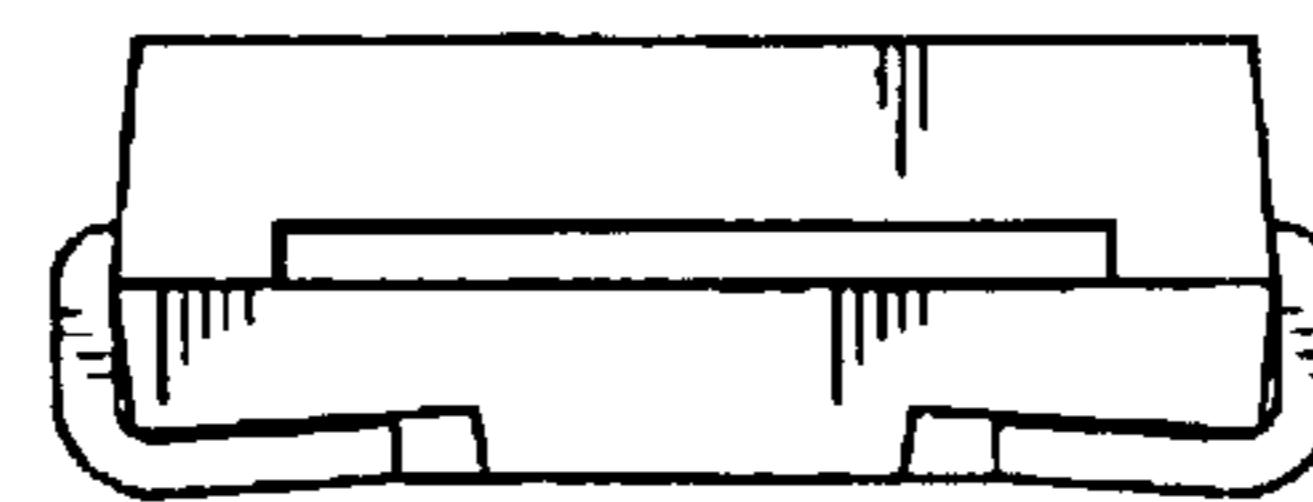


FIG. 13